

NCV8452

Self Protected High Side Driver with Temperature Shutdown and Current Limit

The NCV8452 is a fully protected High-Side driver that can be used to switch a wide variety of loads, such as bulbs, solenoids and other activators. The device is internally protected from an overload condition by an active current limit and thermal shutdown.

Features

- Short Circuit Protection
- Thermal Shutdown with Automatic Restart
- CMOS (3 V/5 V) Compatible Control Input
- Overvoltage Protection and Shutdown
- Output Voltage Clamp for Inductive Switching
- Under Voltage Shutdown
- Loss of Ground Protection
- ESD Protection
- Reverse Battery Protection (with external resistor)
- Very Low Standby Current
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Switch a Variety of Resistive, Inductive and Capacitive Loads
- Can Replace Electromechanical Relays and Discrete Circuits
- Automotive / Industrial

PRODUCT SUMMARY

Symbol	Characteristics	Value	Unit
V_{OV}	Overvoltage Protection	41	V
V_D	Operation Voltage	5 – 34	V
R_{ON}	On-State Resistance	200	m Ω
I_{ILIM}	Output Current Limit	1.0	A



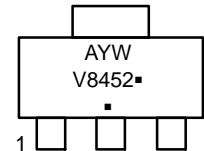
ON Semiconductor®

www.onsemi.com

MARKING DIAGRAM



SOT-223
(TO-261)
CASE 318E



V8452 = Device Code
A = Assembly Location
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

NCV8452

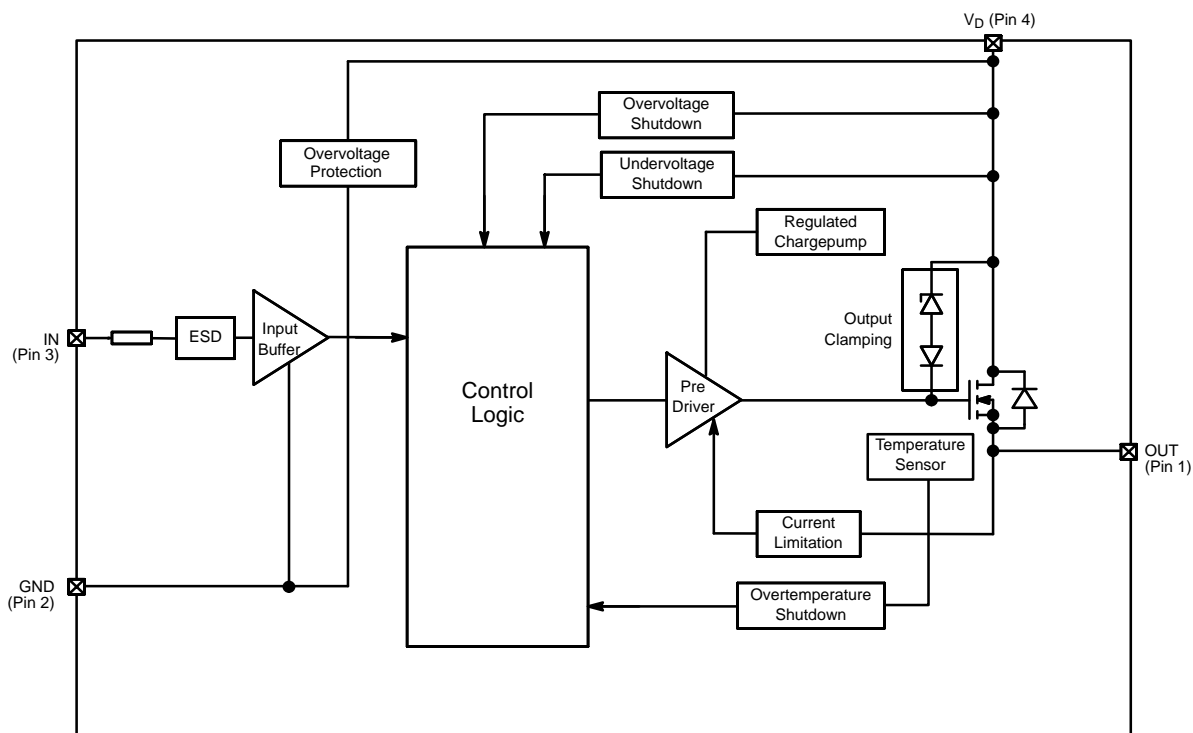


Figure 1. Block Diagram

PACKAGE PIN DESCRIPTION

Pin #	Symbol	Description
1	OUT	Output
2	GND	Ground
3	IN	Logic Level Input
4	V _D	Supply Voltage

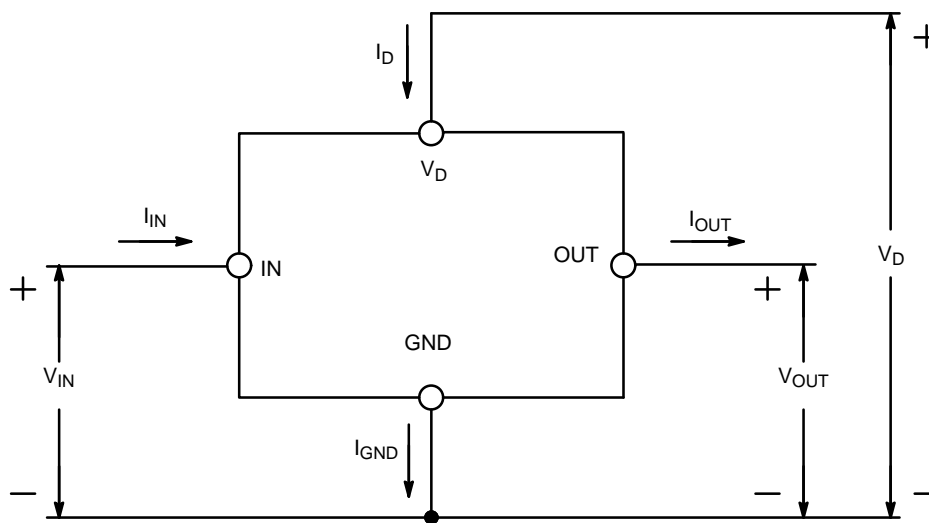


Figure 2. Voltage and Current Definition

NCV8452

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Supply Voltage	V_D	40	V
Peak Transient Input Voltage (Load Dump 37.5 V, $V_D = 13.5$ V, ISO7637-2 pulse5) (Note 1)	V_{peak}	51	V
Input Voltage	V_{IN}	-5 to V_D	V
Input Current	I_{IN}	± 5	mA
Output Current	I_{OUT}	Internally Limited	A
Power Dissipation @ $T_A = 25^\circ\text{C}$ (Note 3) @ $T_A = 25^\circ\text{C}$ (Note 4)	P_D	1.19 1.76	W
Electrostatic Discharge (Note 1) (HBM Model 100 pF / 1500 Ω) Input Output V_D		± 1 ± 5 ± 5	kV
Single Pulse Inductive Load Switch Off Energy (Note 1) ($L = 4.55$ H, $V_D = 13.5$ V; $I_L = 0.5$ A, $T_{Jstart} = 25^\circ\text{C}$)	E_{AS}	0.8	J
Operating Junction Temperature	T_J	-40 to +150	$^\circ\text{C}$
Storage Temperature	$T_{storage}$	-55 to +150	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Not subjected to production testing
2. Reverse Output current has to be limited by the load to stay within absolute maximum ratings and thermal performance.
3. Minimum pad.
4. 1 in square pad size, FR-4, 1 oz Cu.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max Value	Unit
Thermal Resistance (Note 5) Junction-to-Soldering Point	R_{thJS}	10	$^\circ\text{C}/\text{W}$
Junction-to-Ambient (Note 6)	R_{thJA}	105	$^\circ\text{C}/\text{W}$
Junction-to-Ambient (Note 7)	R_{thJA}	71	$^\circ\text{C}/\text{W}$

5. Reverse Output current has to be limited by the load to stay within absolute maximum ratings and thermal performance.
6. Minimum pad.
7. 1 in square pad size, FR-4, 1 oz Cu.

NCV8452

ELECTRICAL CHARACTERISTICS ($V_D = 13.5\text{ V}$; $-40^\circ\text{C} < T_J < 150^\circ\text{C}$ unless otherwise specified)

Rating	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Operating Supply Voltage	V_D		5	–	34	V
Undervoltage Shutdown	V_{UV}		2.5		5.5	V
Undervoltage Restart	$V_{UV(res)}$				6.0	V
Undervoltage Hysteresis	$V_{UV(hyst)}$			0.3		
Overvoltage Shutdown	V_{OV}		34		42	V
Overvoltage Restart	$V_{OV(res)}$		33			
On–state Resistance	R_{ON}	$I_{OUT} = 0.5\text{ A}$, $V_{IN} = 5\text{ V}$, $T_J = 25^\circ\text{C}$ $I_{OUT} = 0.5\text{ A}$, $V_{IN} = 5\text{ V}$, $T_J = 150^\circ\text{C}$		160 –	200 400	m Ω
Standby Current	$I_{D(off)}$	$V_{IN} = V_{OUT} = 0\text{ V}$		12	25	μA
Active Ground Current	$I_{GND(on)}$	$V_{IN} = 5\text{ V}$		1	1.8	mA
Output Leakage Current	$I_{OUT(off)}$	$V_{IN} = 0\text{ V}$			2	μA

INPUT CHARACTERISTICS

Input Voltage – Low	$V_{IN(low)}$				0.8	V
Input Voltage – High	$V_{IN(high)}$		2.2			V
Off State Input Current	$I_{IN(off)}$	$V_{IN} = 0.7\text{ V}$			10	μA
On State Input Current	$I_{IN(on)}$	$V_{IN} = 5.0\text{ V}$			10	μA
Input Threshold Hysteresis	$V_{IN(hyst)}$			0.3		V
Input Resistance	R_I		1.5	2.8	3.5	k Ω

SWITCHING CHARACTERISTICS

Turn–On Time	t_{on}	to 90% V_{OUT} , $R_L = 24\ \Omega$		60	120	μs
Turn–Off Time	t_{off}	to 10% V_{OUT} , $R_L = 24\ \Omega$		60	120	μs
Slew Rate On	dV_{OUT}/dt_{on}	10% to 30% V_{OUT} , $R_L = 24\ \Omega$		1	4	V / μs
Slew Rate Off	dV_{OUT}/dt_{off}	70% to 40% V_{OUT} , $R_L = 24\ \Omega$		1	4	V / μs

REVERSE BATTERY (Note 8)

Reverse Battery	$-V_D$	Requires a 150 Ω Resistor in GND Connection			32	V
Forward Voltage	V_F	$T_J = 150^\circ\text{C}$		0.6		V

PROTECTION FUNCTIONS (Note 9)

Temperature Shutdown (Note 8)	TSD		150	175	200	$^\circ\text{C}$
Temperature Shutdown Hysteresis (Note 8)	TSD _(hyst)			10		$^\circ\text{C}$
Overvoltage Protection	V_{OV}	$I_D = 4\text{ mA}$	41			V
Switch Off Output Clamp Voltage	V_{CLAMP}	$I_D = 4\text{ mA}$, $V_{IN} = 0\text{ V}$	$V_D - 41$	$V_D - 47$		V
Output Current Limit Initial Peak	I_{LIM}	$V_D = 20\text{ V}$, $T_J = 25^\circ\text{C}$ $T_J = -40^\circ\text{C}$ to 150°C	1.0	1.8 –	3	A

8. Not subjected to production testing

9. To ensure long term reliability under heavy overload or short circuit conditions, protection and related diagnostic signals must be used together with a proper hardware/software strategy. If the devices operates under abnormal conditions this hardware/software solutions must limit the duration and number of activation cycles.

NCV8452

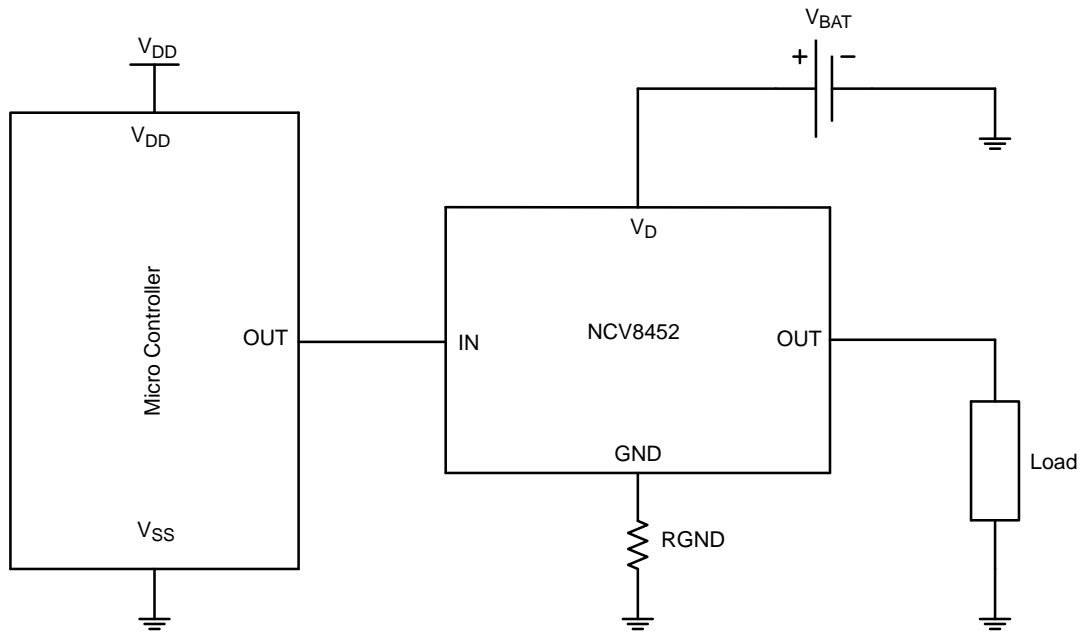


Figure 3. Application Diagram

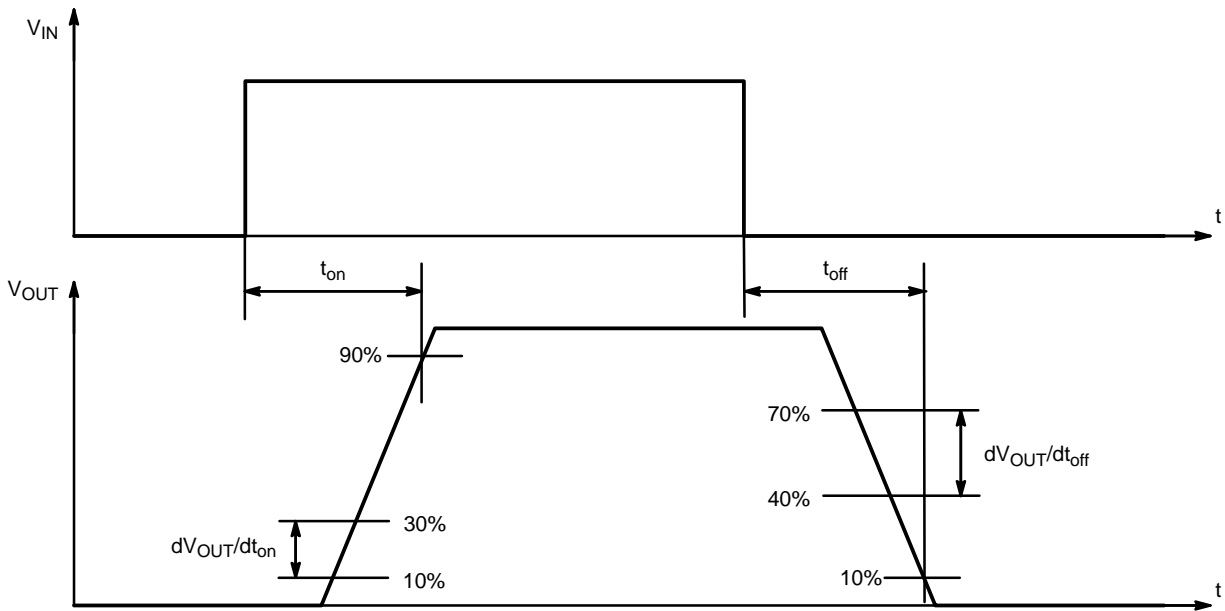


Figure 4. Resistive Load Switching Waveform

TYPICAL CHARACTERISTIC CURVES

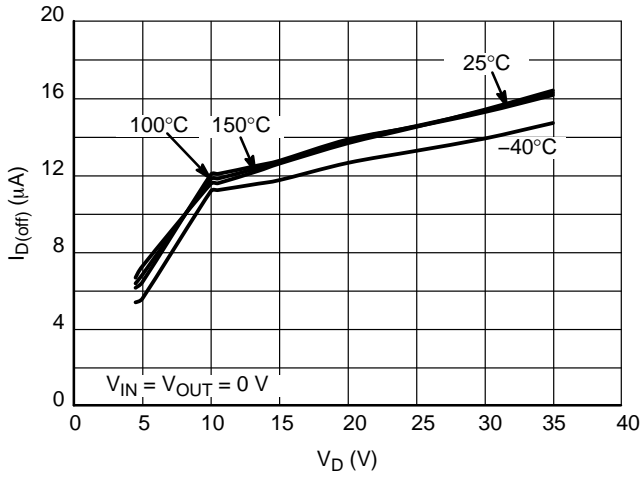


Figure 5. Standby Current vs. Supply Voltage

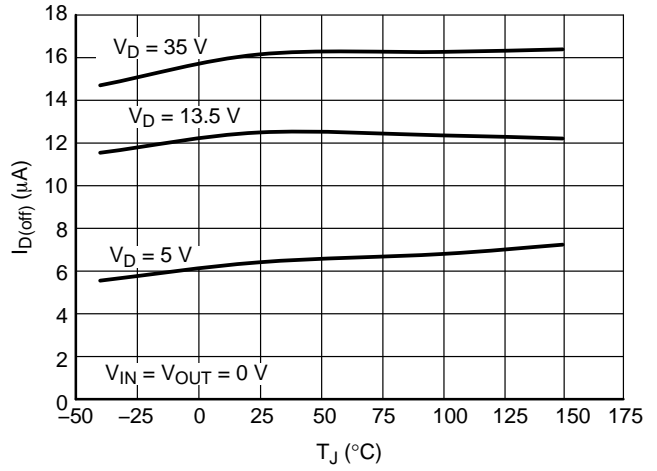


Figure 6. Standby Current vs. Junction Temperature

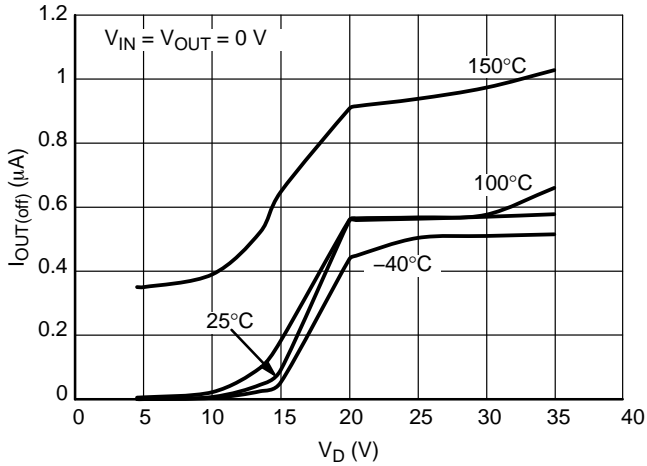


Figure 7. Output Leakage Current vs. Supply Voltage

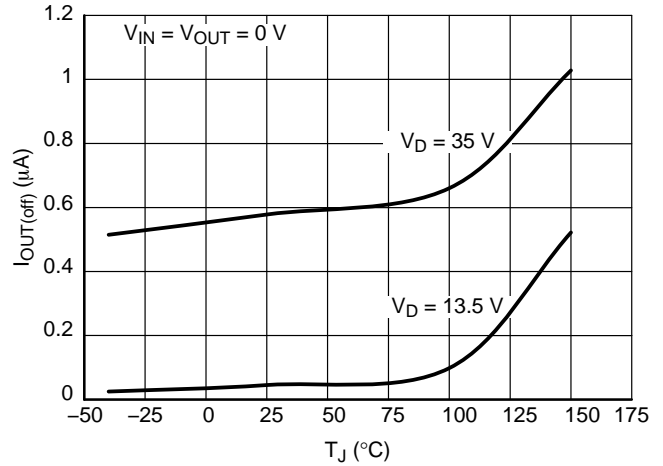


Figure 8. Output Leakage Current vs. Junction Temperature

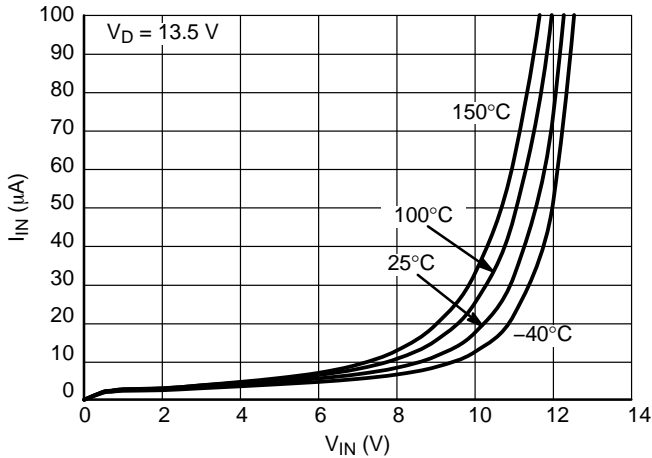


Figure 9. Input Current vs. Input Voltage

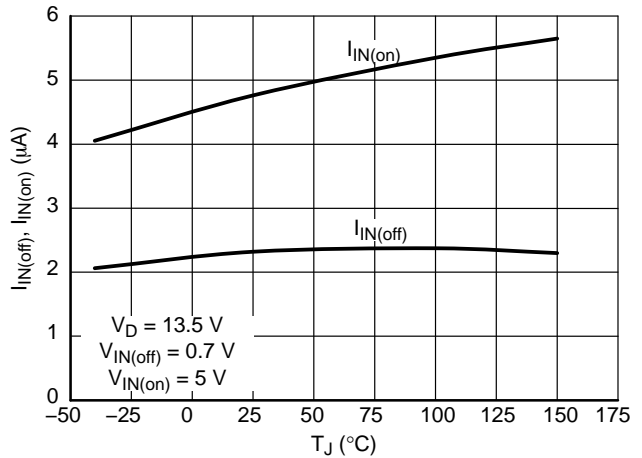


Figure 10. Input Current vs. Junction Temperature

TYPICAL CHARACTERISTIC CURVES

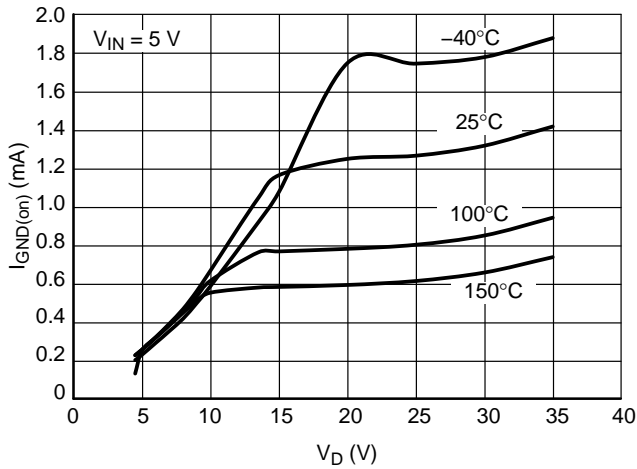


Figure 11. Active Ground Current vs. Supply Voltage

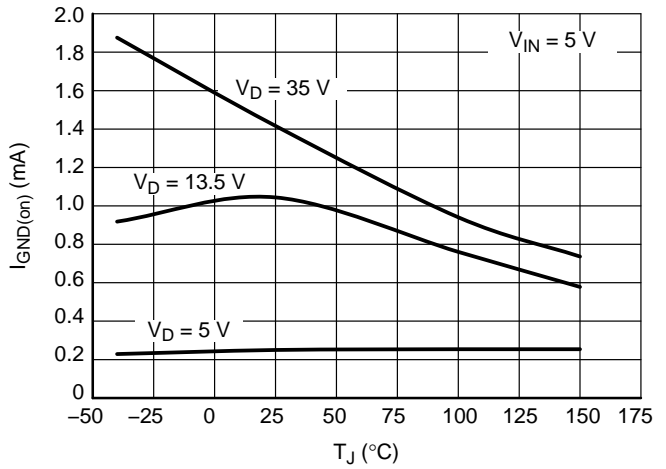


Figure 12. Active Ground Current vs. Junction Temperature

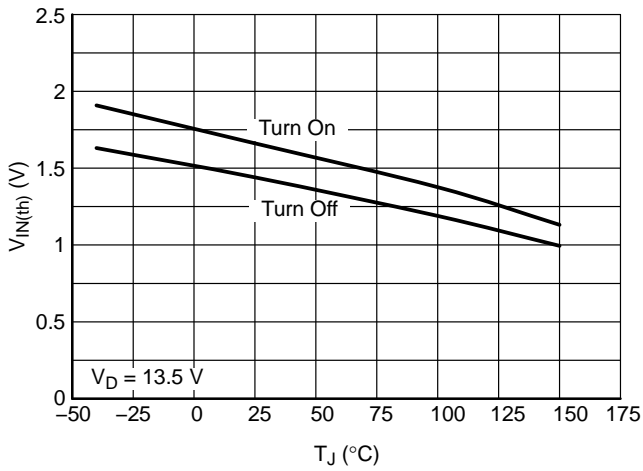


Figure 13. Input Threshold Voltage vs. Junction Temperature

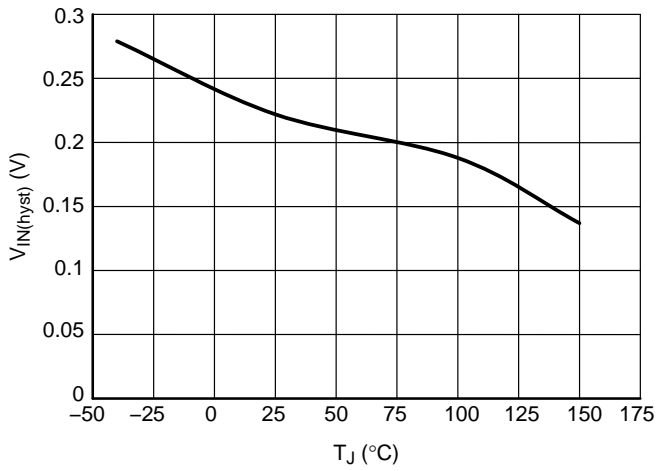


Figure 14. Input Threshold Hysteresis vs. Junction Temperature

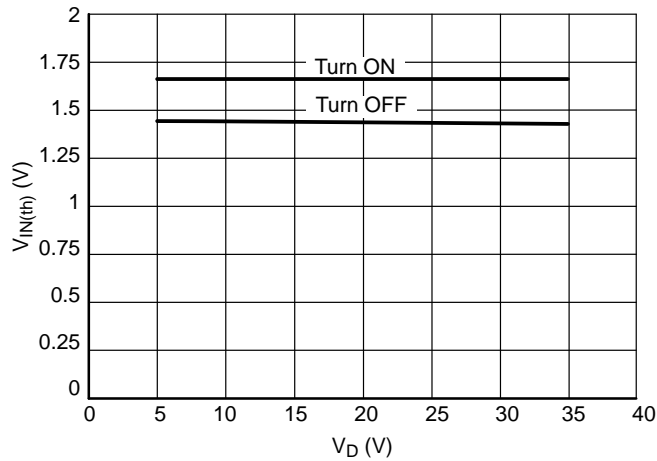


Figure 15. Input Threshold Voltage vs. Supply Voltage

TYPICAL CHARACTERISTIC CURVES

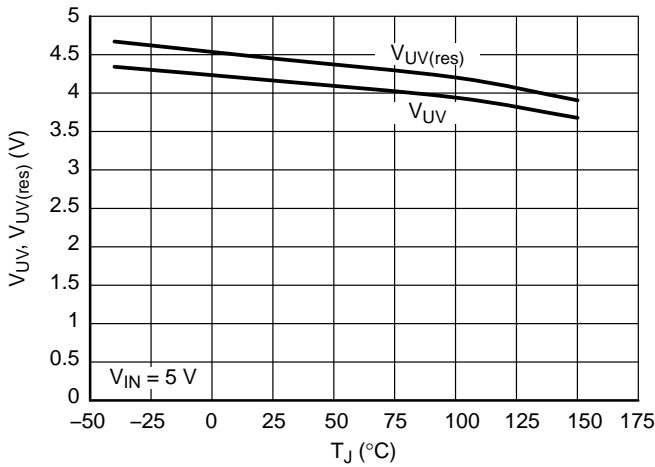


Figure 16. Under Voltage Shutdown and Restart vs. Junction Temperature

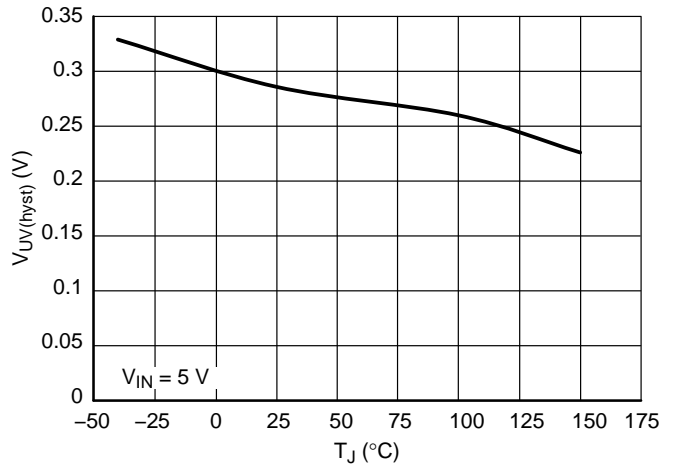


Figure 17. Under Voltage Shutdown Hysteresis vs. Junction Temperature

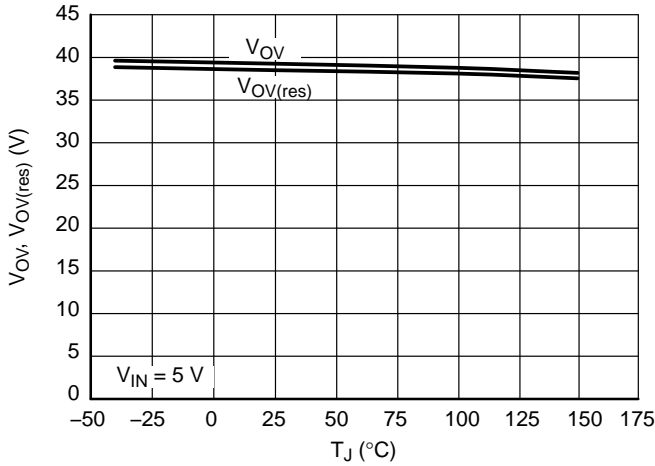


Figure 18. Over Voltage Shutdown vs. Junction Temperature

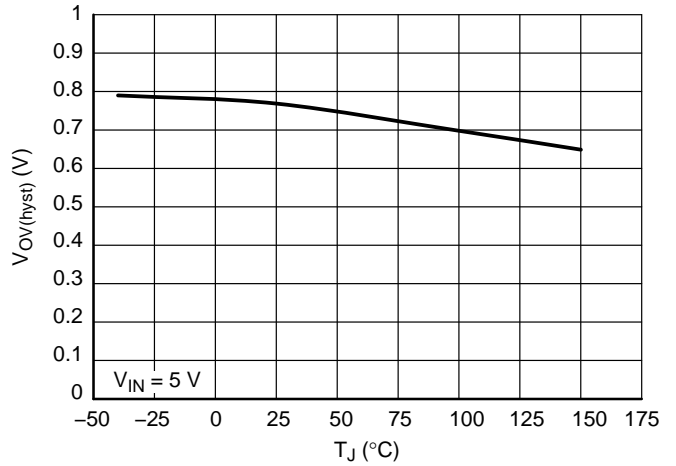


Figure 19. Over Voltage Shutdown Hysteresis vs. Junction Temperature

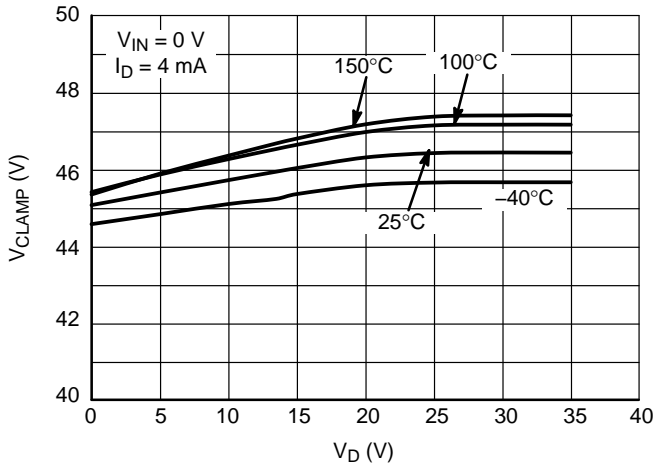


Figure 20. Output Clamp Voltage vs. Supply Voltage

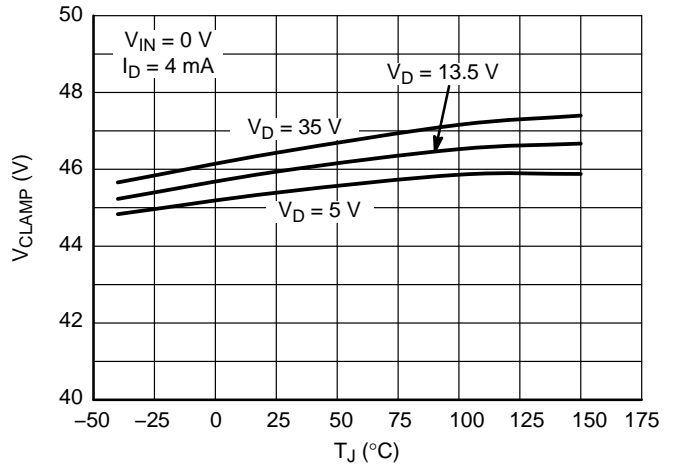


Figure 21. Output Clamp Voltage vs. Junction Temperature

TYPICAL CHARACTERISTIC CURVES

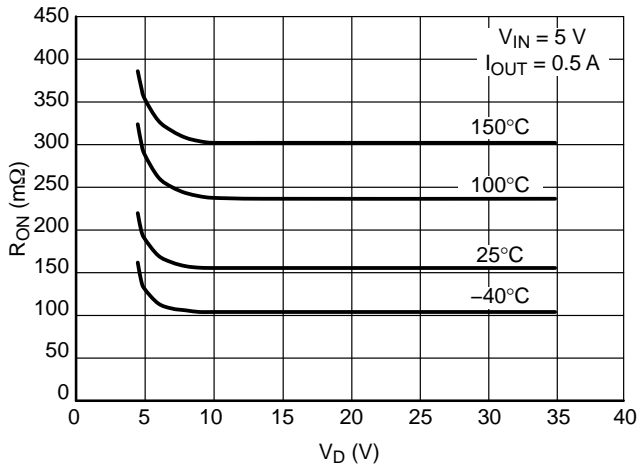


Figure 22. On-state Resistance vs. Supply Voltage

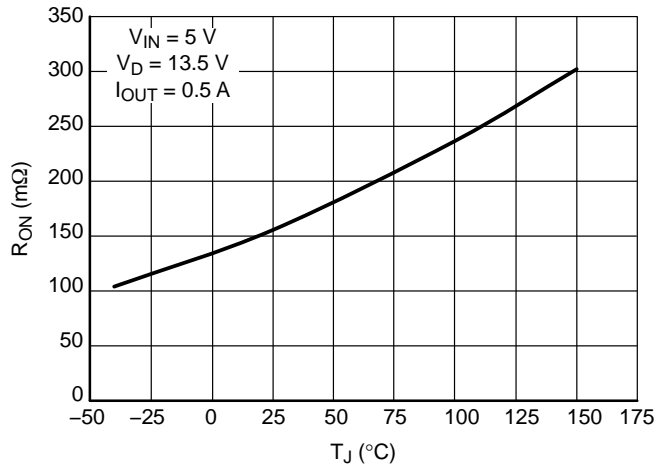


Figure 23. On-state Resistance vs. Junction Temperature

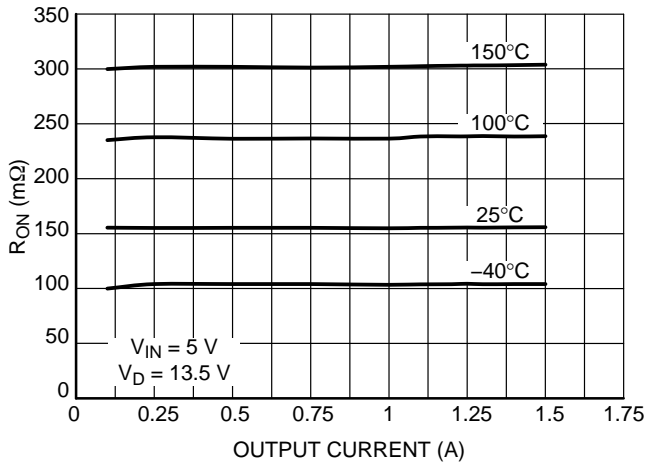


Figure 24. On-state Resistance vs. Output Current

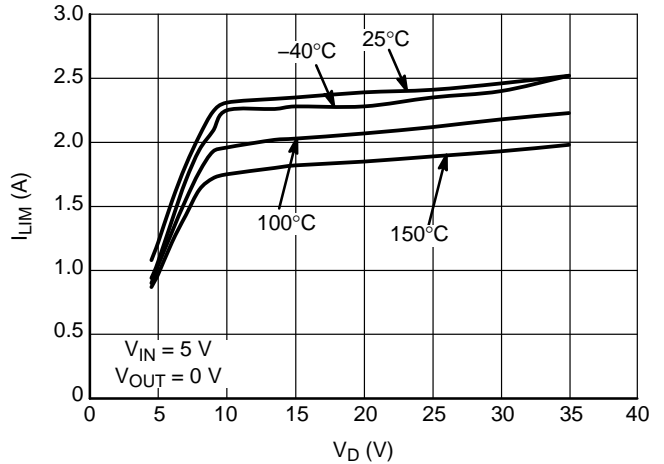


Figure 25. Current Limit vs. Supply Voltage

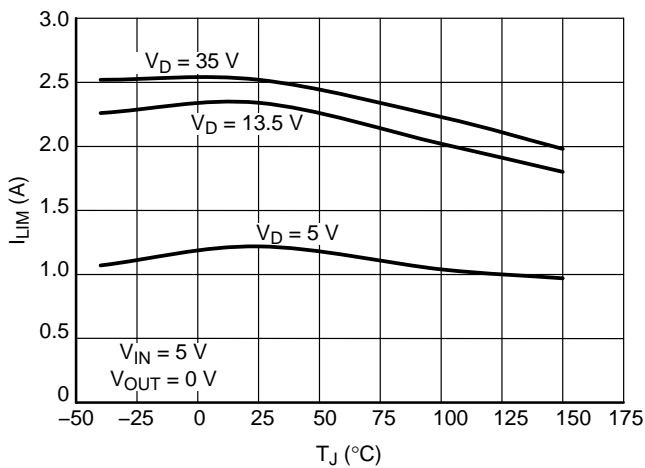


Figure 26. Current Limit vs. Junction Temperature

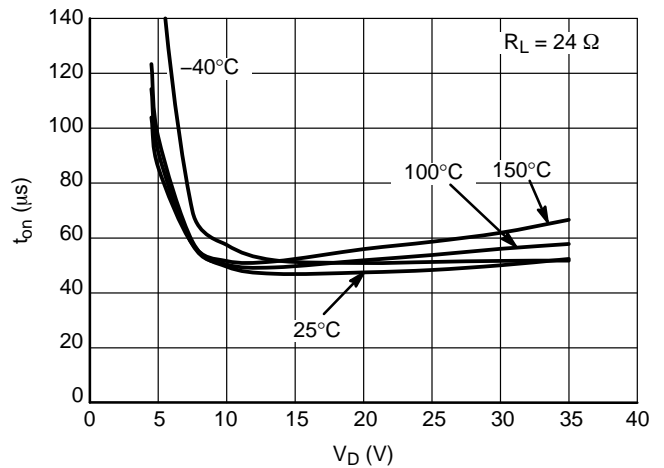


Figure 27. Turn-On Time vs. Supply Voltage

TYPICAL CHARACTERISTIC CURVES

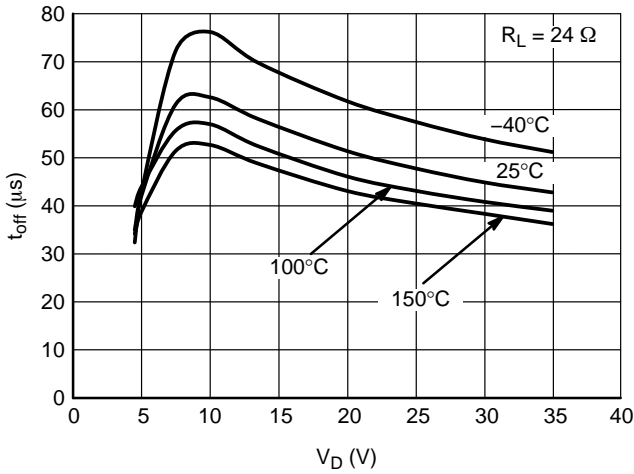


Figure 28. Turn-Off Time vs. Supply Voltage

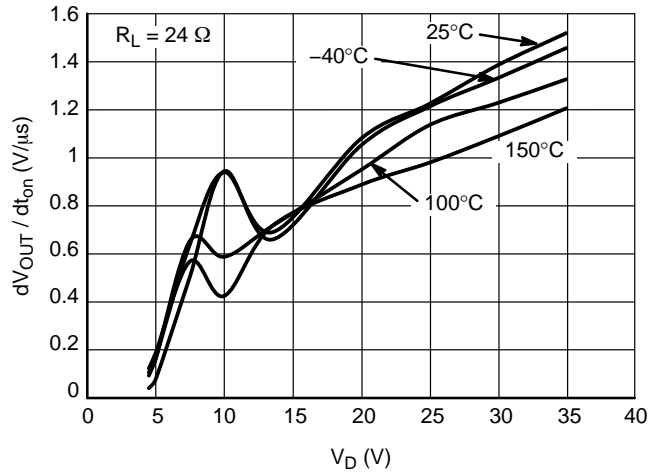


Figure 29. Slew Rate On vs. Supply Voltage

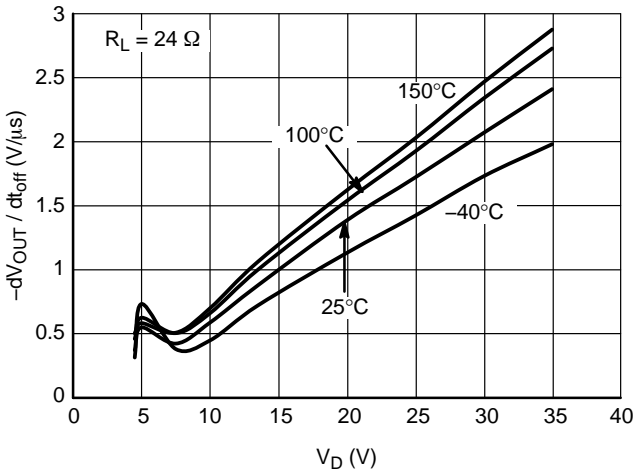


Figure 30. Slew Rate Off vs. Supply Voltage

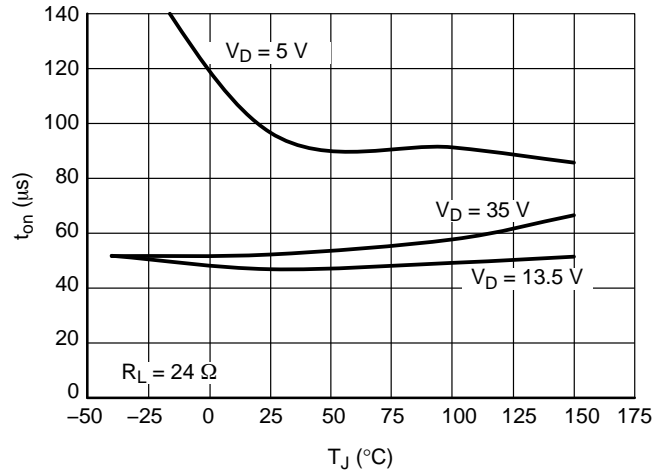


Figure 31. Turn-On vs. Junction Temperature

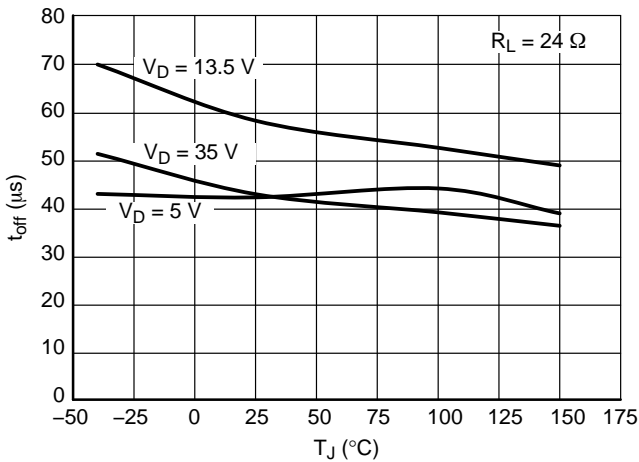


Figure 32. Turn-Off Time vs. Junction Temperature

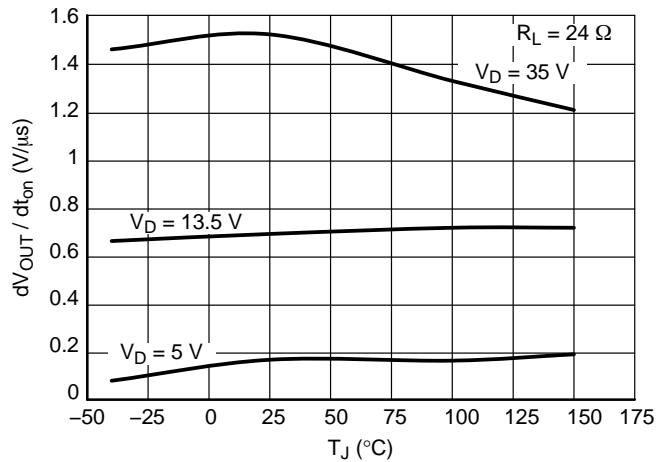


Figure 33. Slew Rate On vs. Junction Temperature

TYPICAL CHARACTERISTIC CURVES

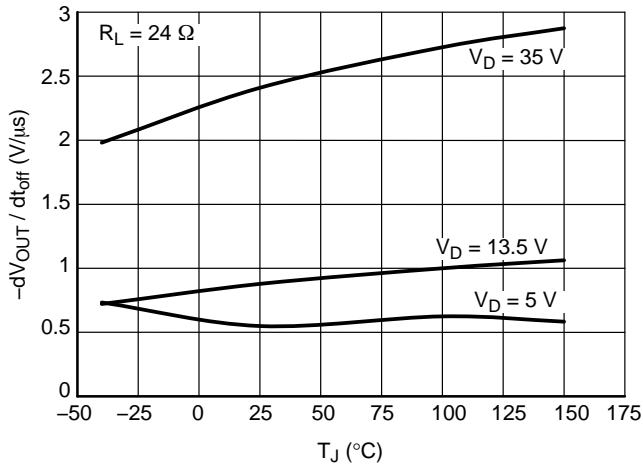


Figure 34. Slew Rate Off vs. Junction Temperature

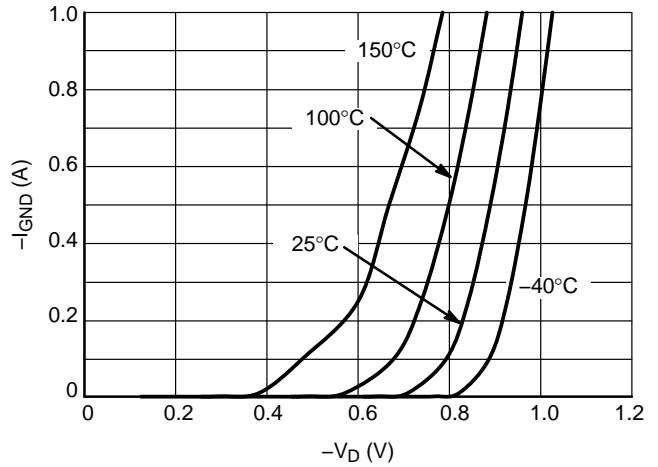


Figure 35. Supply-to-Ground Reverse Characteristics

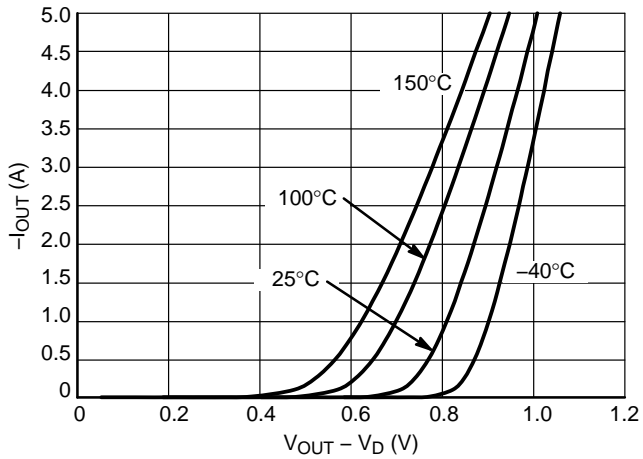


Figure 36. Power FET Body Forward Characteristics

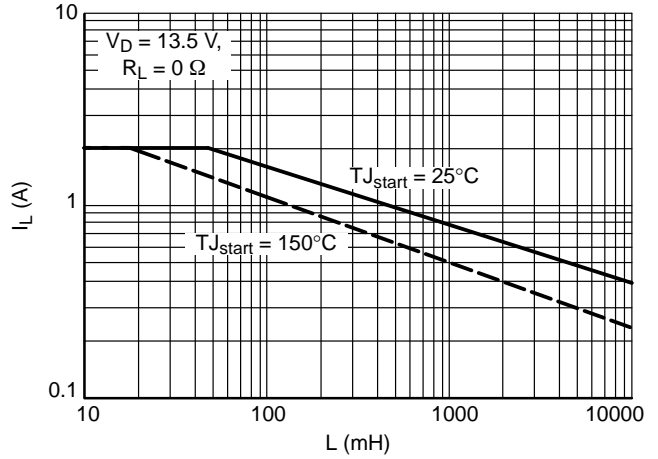


Figure 37. Single Pulse Maximum Switch Off Current vs. Load Inductance

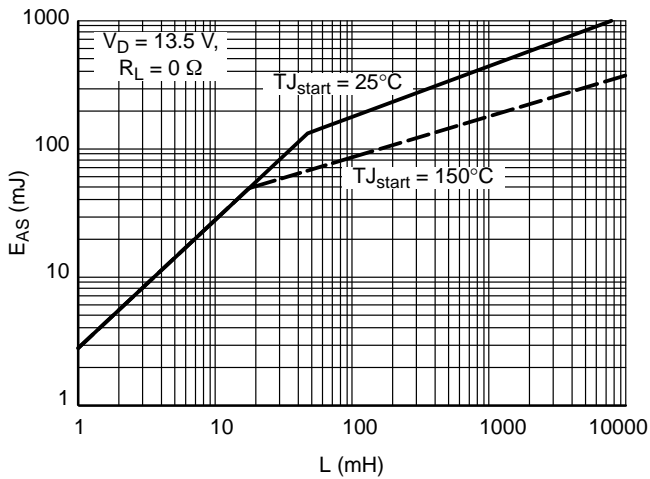


Figure 38. Single Pulse Maximum Switch Off Energy vs. Load Inductance

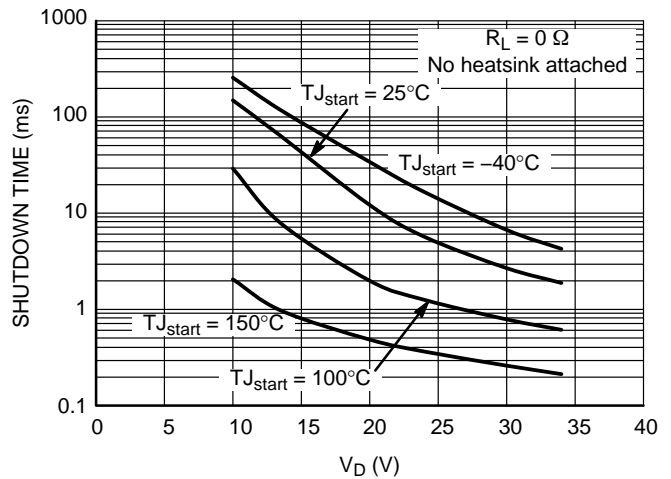


Figure 39. Initial Short-Circuit Shutdown Time vs. Supply Voltage

NCV8452

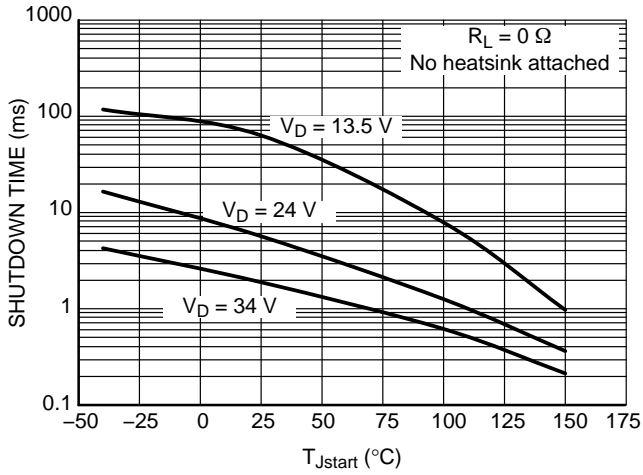


Figure 40. Initial Short-Circuit Shutdown Time vs. Starting Junction Temperature

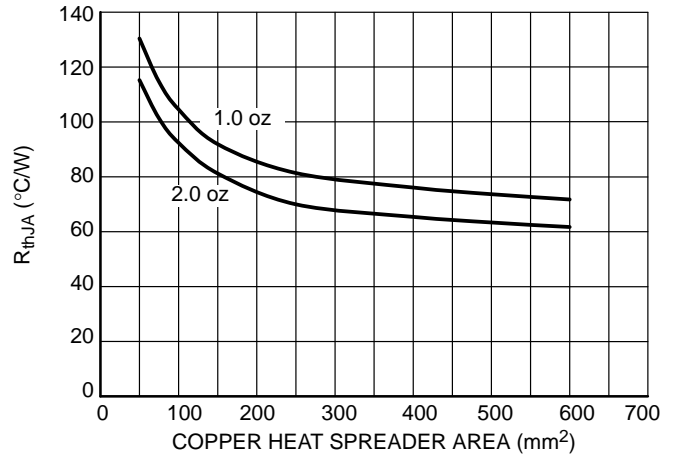


Figure 41. Junction-to-Ambient Thermal Resistance vs. Copper Area

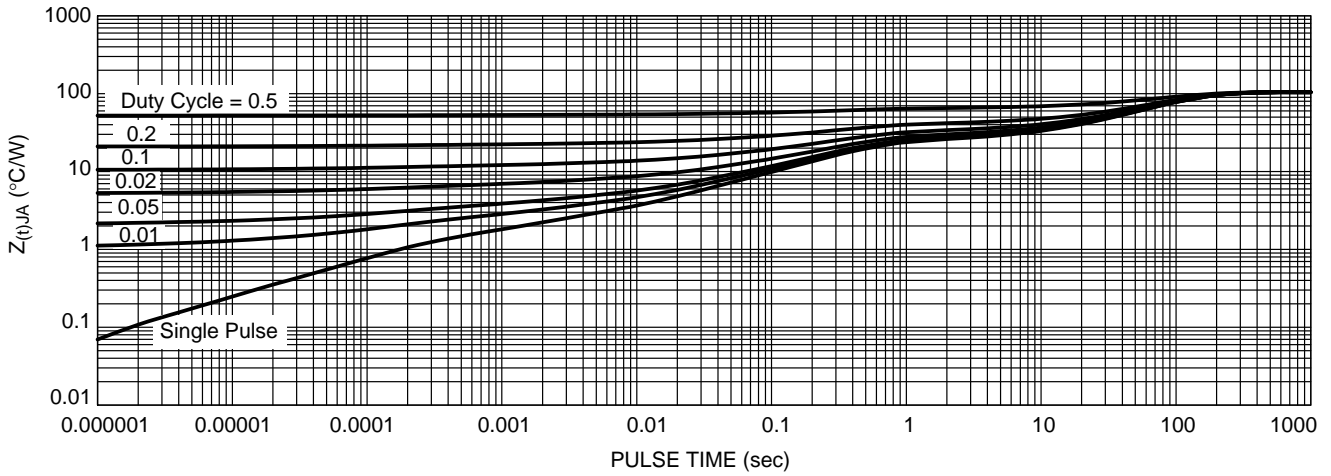


Figure 42. Junction-to-Ambient Transient Thermal Impedance (minimum pad size)

ORDERING INFORMATION

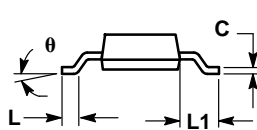
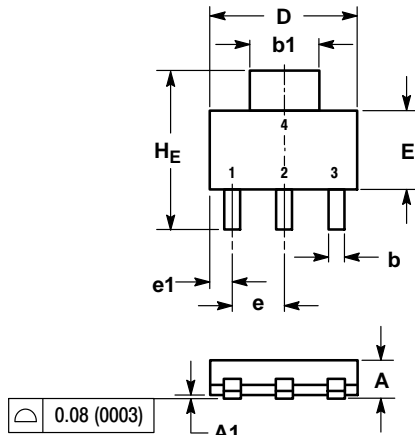
Device	Package	Shipping†
NCV8452STT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel
NCV8452STT3G	SOT-223 (Pb-Free)	4000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NCV8452

PACKAGE DIMENSIONS

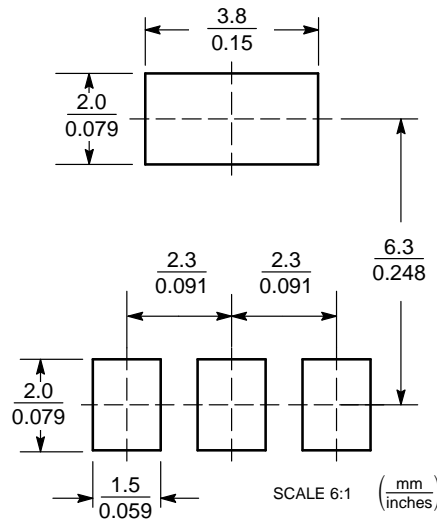
SOT-223 (TO-261) CASE 318E-04 ISSUE N



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
c	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
E	3.30	3.50	3.70	0.130	0.138	0.145
e	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L	0.20	---	---	0.008	---	---
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	-	10°	0°	-	10°

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and the are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>
For additional information, please contact your local Sales Representative